

WEBINAR

Next Generation of Convection Soldering - Focus on Resource Efficiency and Digitalization



October 31st, 2024 at 9.00 a.m. and 4.00 p.m.

Convection soldering has been utilized for decades as a robust and cost-effective joining process for manufacturing electronic assemblies. This method has continuously evolved in response to various requirements. The ongoing situation regarding the availability of resources such as electrical energy and nitrogen, coupled with the simultaneous goal of reducing CO2 emissions, presents new objectives and challenges for both equipment development and soldering process definition.

In this webinar, our speakers will introduce Rehm's response to these new requirements – VXP+ Next Generation.

October 31st, 2024 at 9:00 a.m. CET (for Asia, Europe, ROW)

October 31st, 2024 at 4:00 p.m. CET (for Americas, Europe)

Registration:

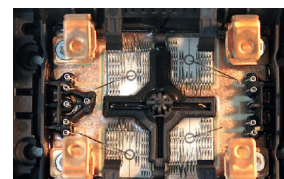
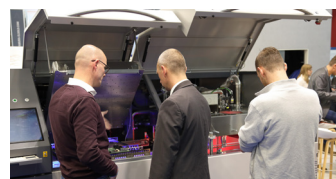
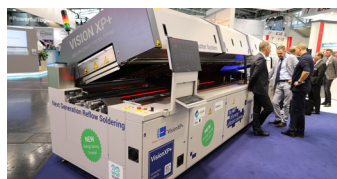
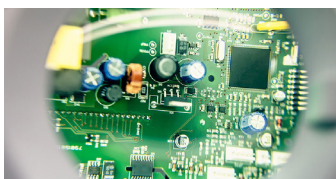
s.bartosch@rehm-group.com

Duration of the webinar: 60 min

Main topics of the webinar

- Increasing resource efficiency
- Extending maintenance intervals
- Process and equipment monitoring

Subject to substantive adjustments



TECHNOLOGY ACADEMY